TOSHIBA Power MOS FET Module Silicon P Channel MOS Type (Four L²-π-MOSV inOne)

MP4211

High Power, High Speed Switching Applications For Printer Head Pin Driver and Pulse Motor Driver For Solenoid Driver

- 4-V gate drivability •
- Small package by full molding (SIP 10 pin)
- High drain power dissipation (4 devices operation) $: P_{T} = 4 W (Ta = 25^{\circ}C)$
- Low drain-source ON resistance: RDS (ON) = 0.16Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 4.0 \text{ S}$ (typ.)
- Low leakage current: IGSS = $\pm 10 \mu A (max) (VGS = \pm 16 V)$
 - $I_{DSS} = -100 \ \mu A \ (max) \ (V_{DS} = -60 \ V)$
- Enhancement-mode: $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10$ V, $I_D = -1$ mA)

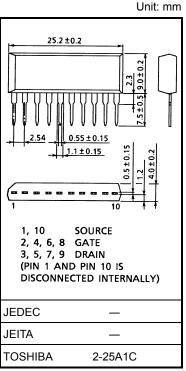
Characteristics Symbol Rating Unit Drain-source voltage -60 V VDSS Drain-gate voltage (R_{GS} = 20 kΩ) -60 V VDGR V Gate-source voltage ±20 V_{GSS} DC I_D -5 Drain current А Pulse -20 IDP Drain power dissipation PD 2.0 W (1-device operation, Ta = 25°C) Drain power dissipation W PDT 4.0 (- device operation, Ta = 25°C) Single pulse avalanche energy EAS 273 mJ (Note 1) Avalanche current I_{AR} -5 А 1-device 0.2 E_{AR} operation Repetitive avalanche mJ energy (Note 2) 4-device EART 0.4 operation Channel temperature 150 °C T_{ch} Storage temperature range Tstg -55 to 150 °C

Maximum Ratings ($Ta = 25^{\circ}C$)

Note 1:	Condition for avalanche energy (single pulse) measurement
	V_{DD} = -25 V, starting T _{ch} = 25°C, L = 14.84 mH, R _G = 25 Ω , I _{AR} = -5 A

Note 2: Repetitive rating; pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.

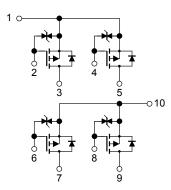


Industrial Applications

Weight: 2.1 g (typ.)

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Array Configuration



Thermal Characteristics

Characteristics	Symbol	Max	Unit	
Thermal resistance from channel to ambient	ΣR _{th (ch-a)}	31.2	°C/W	
(4-device operation, Ta = 25°C)	- (/			
Maximum lead temperature for soldering purposes	ΤL	260	°C	
(3.2 mm from case for t = 10 s)				

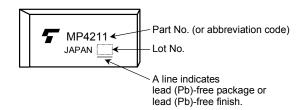
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Мах	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	—	±10	μA
Drain cut-off current		I _{DSS}	V_{DS} = -60 V, V_{GS} = 0 V	_	_	-100	μA
Drain-source breakdown voltage		V (BR) DSS	I _D = -10 mA, V _{GS} = 0 V	-60	_	_	V
Gate threshold voltage		V _{th}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-0.8	-	-2.0	V
Drain-source ON resistance		D	V_{GS} = -4 V, I _D = -2.5 A	-	0.24	0.28	Ω
		R _{DS (ON)}	V_{GS} = -10 V, I _D = -2.5 A	-	0.16	0.19	
Forward transfer admittance		Y _{fs}	V_{DS} = -10 V, I _D = -2.5 A	2.0	4.0	_	S
Input capacitance		C _{iss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	630	-	pF
Reverse transfer capacitance		C _{rss}		_	95	-	pF
Output capacitance		C _{oss}		_	290	-	pF
Switching time	Rise time	tr	V_{GS} $-10 V$ $V_{DD} \approx -30 V$ $I_{D} = -2.5 A$ V_{OUT} C	_	25	_	
	Turn-on time	t _{on}		-	45	_	20
	Fall time	t _f		_	55	_	- ns
	Turn-off time	t _{off}	V_{IN} : t _r , t _f < 5 ns, duty ≤ 1%, t _w = 10 µs		200	_	
Total gate charge (Gate-source plus gate-drain)		Qg	— V _{DD} ≈ −48 V, V _{GS} = −10 V, I _D = −5 A	_	22	_	nC
Gate-source charge		Q _{gs}		_	16	_	nC
Gate-drain ("miller") charge		Q _{gd}]	_	6	_	nC

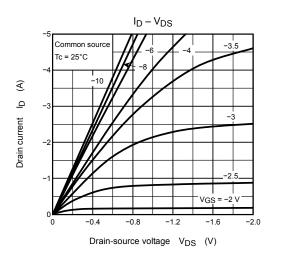
Source-Drain Diode Ratings and Characteristics (Ta = 25°C)

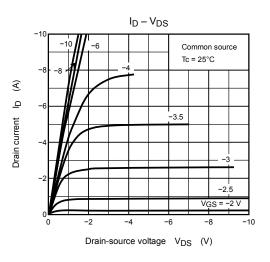
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current	I _{DR}	—	—	_	-5	А
Pulse drain reverse current	I _{DRP}	—	_	_	-20	А
Diode forward voltage	V _{DSF}	I_{DR} = -5 A, V_{GS} = 0 V	_	_	1.7	V
Reverse recovery time	t _{rr}	I _{DR} = -5 A, V _{GS} = 0 V	_	80	_	ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 50 A/µs		0.1	_	μC

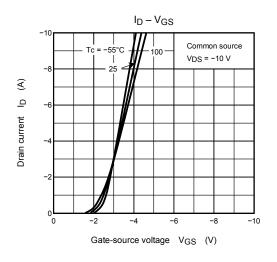
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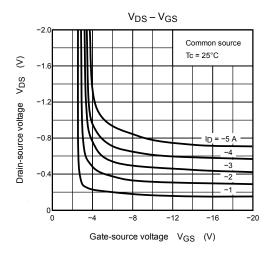


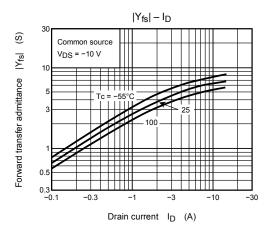
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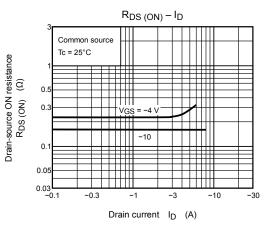




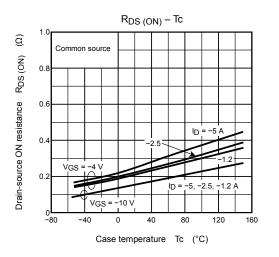


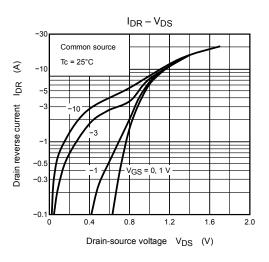


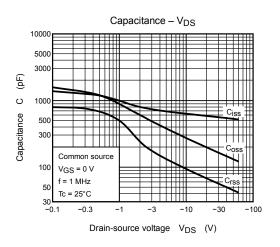


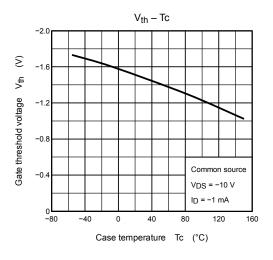


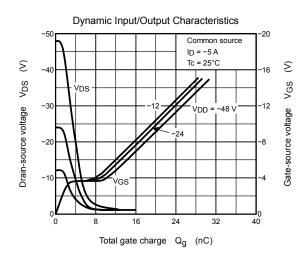
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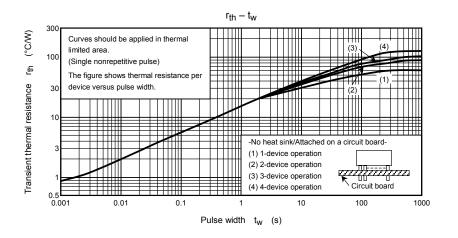


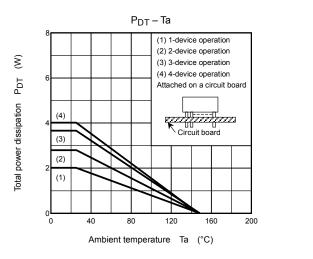


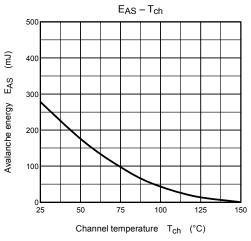


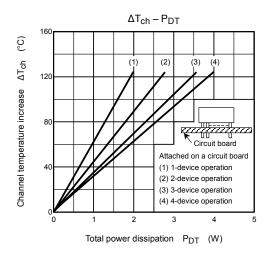


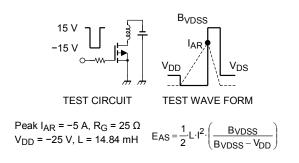
Safe Operating Area -3 IDP max 100 µs* -10 E ID ma _ Drain current ++++ 10 ms 100 ms Single nonrepetitive pulse Tc = 25°C -0.3 Curves must be derated linearly with increase in temperature -0.1 -1 -3 -10 -30 -100 -300 Drain-source voltage V_{DS} (V)











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